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Held
11/7/02

Docket No.: 1614.1142

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Shunji BABA

Serial No. 09/811,605

Group Art Unit: 1762

Confirmation No. 9323

Filed: March 20, 2001

Examiner: Brian K. Talbot

For: RESIN COATING METHOD (AS AMENDED)

AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

CERTIFICATE UNDER 37 CFR 1.3(a)
I hereby certify that this correspondence is being de-
posited with the United States Postal Service as first
class mail in an envelope addressed to: Commissioner
of Patents and Trademarks, Washington, D.C. 20231
on 9-15
STAAS & HALSEY, 2002
By: B. K. Talbot
Date: 11-15-02

This is in response to the Office Action mailed April 15, 2002, and having a period for
response set to expire on July 15, 2002.

The following amendments and remarks are respectfully submitted. Reconsideration of
the claims is respectfully requested.

IN THE TITLE:

Please AMEND the Title as follows: Title - RESIN COATING METHOD--.

IN THE CLAIMS:

Please AMEND the following claims:

1. (ONCE AMENDED) A resin coating method for applying resin to a
predetermined amount of resin region of on a printed wiring board, comprising the steps of:
applying a resin on a printed wiring board;
spreading said resin on said printed wiring board by a centrifugal force; and
imaging an external appearance of the resin extruded from a resin application device;

and

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